

RoHS Compliant Product
A suffix of "-C" specifies halogen free

FEATURES

- Trench Barrier Schottky Technology
- Low Forward Voltage Drop
- Low Reverse Current
- High Current Capability
- High Reliability
- High Surge Current Capability
- Epitaxial Construction

MECHANICAL DATA

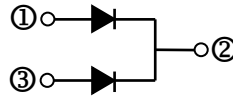
- Case: Molded plastic
- Epoxy: UL 94V-0 rate flame retardant
- Lead: Lead solderable per MIL-STD-202 method 208 guaranteed
- Polarity: As marked
- Mounting position: Any

PACKAGE INFORMATION

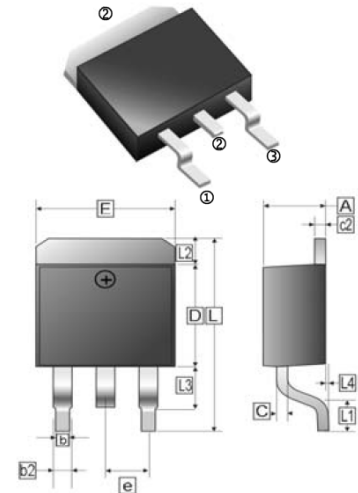
Package	MPQ	Leader Size
TO-263	0.8K	13 inch

ORDER INFORMATION

Part Number	Type
SM3080D	Lead (Pb)-free
SM3080D-C	Lead (Pb)-free and Halogen-free



TO-263



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	4.00	4.87	c2	1.07	1.65
b	0.51	1.01	b2	1.34 REF	
L4	0.00	0.30	D	8.0	9.65
C	0.30	0.74	e	2.54 REF	
L3	1.50 REF		L	14.6	16.1
L1	2.50 REF		L2	1.27 REF	
E	9.60	10.67			

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, de-rate current by 20%.)

Parameter	Symbol	Rating	Unit
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	80	V
Working Peak Reverse Voltage	V_{RSM}	80	V
Maximum DC Blocking Voltage	V_{DC}	80	V
Maximum Average Forward Rectified Current	(Per Leg)	15	A
	(Per Device)	30	
Peak Forward Surge Current, 8.3ms single half sine-wave Superimposed on rated load (JEDEC method)	I_{FSM}	150	A
Voltage Rate of Change (Rated V_R)	dv/dt	10000	V/ μ s
Typical Thermal Resistance ³	$R_{\theta JC}$	3	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-40~150	°C

ELECTRICAL CHARACTERISTICS

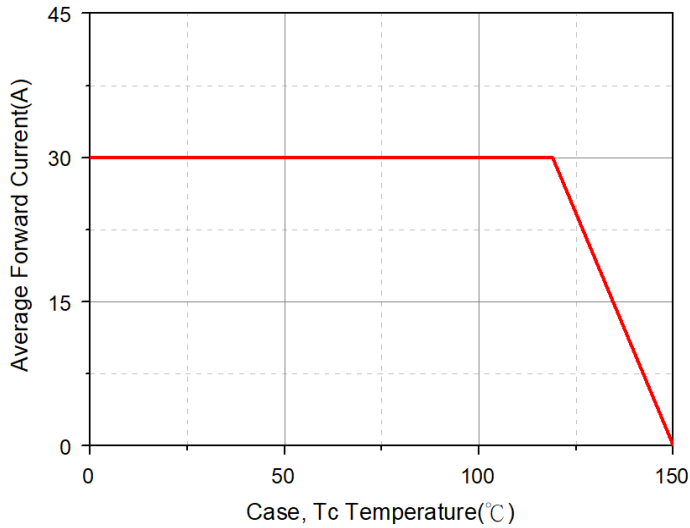
Parameter	Symbol	Typ.	Max.	Unit	Test Condition
Maximum Instantaneous Forward Voltage	V_F	0.6	0.63	V	$I_F=10A, T_J=25^\circ C$
		0.66	0.69		$I_F=15A, T_J=25^\circ C$
		0.64	-		$I_F=15A, T_J=100^\circ C$
Maximum DC Reverse Current at Rated DC Blocking Voltage ²	I_R	-	0.2	mA	$T_J=25^\circ C$
		-	20		$T_J=100^\circ C$
Typical Junction Capacitance ¹	C_J	750	-	pF	

Notes:

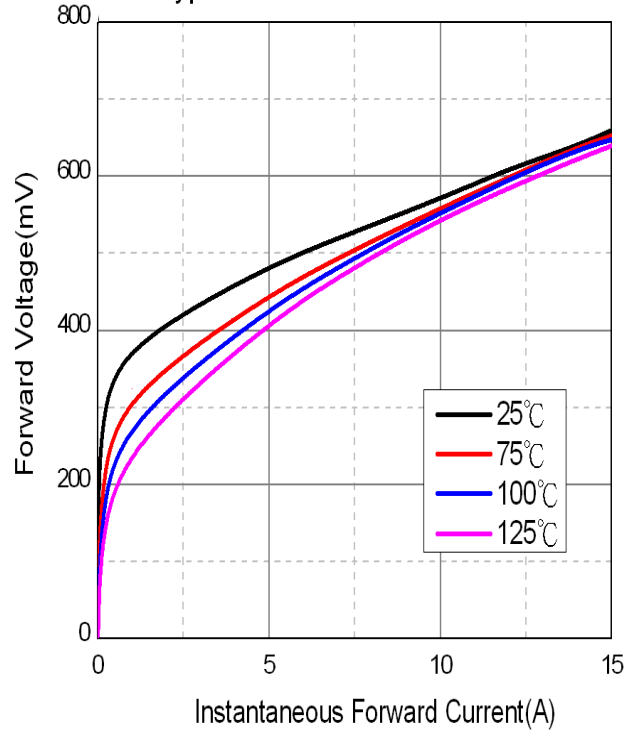
1. Measured at 1MHz and applied reverse voltage of 4V D.C.
2. Pulse Test: Pulse Width=300 μ s, Duty Cycle \leq 2%.
3. Thermal Resistance Junction to Case. FR-4 Board Heat sink size: 10*10*0.2mm.

RATINGS AND CHARACTERISTIC CURVES

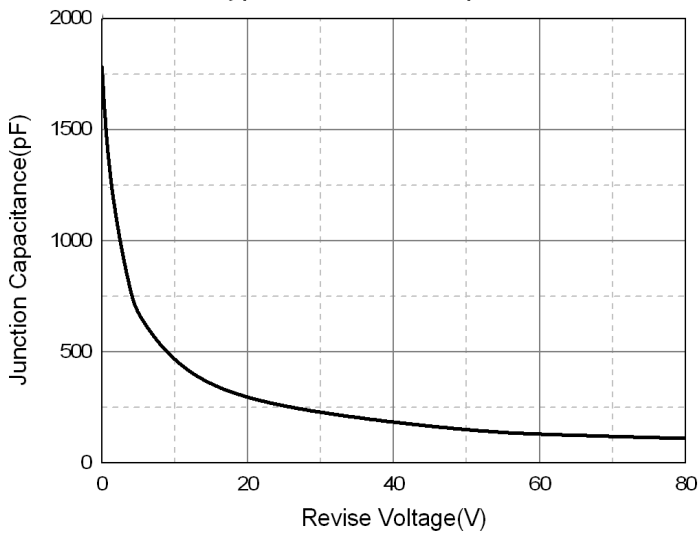
Typical Forward Current Derating Curve



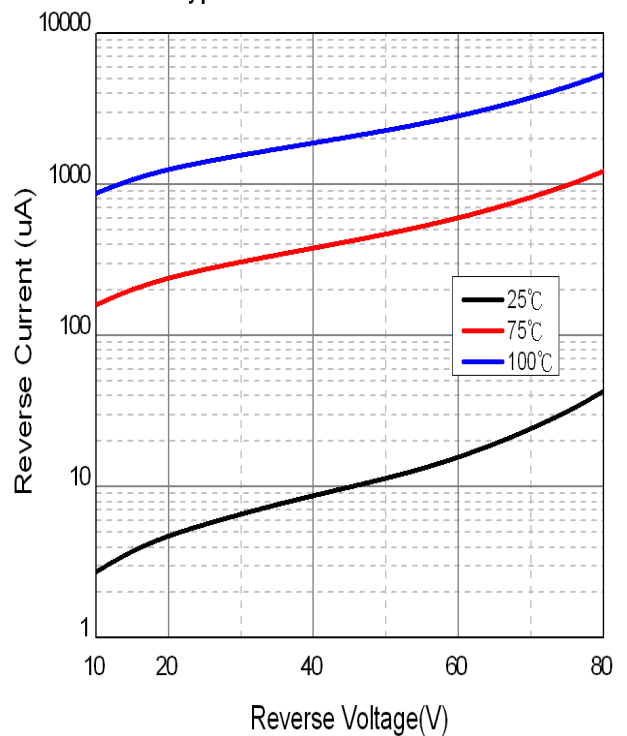
Typical Forward Characteristic



Typical Junction Capacitance



Typical Reverse Characteristic



Maximum Non-Repetitive Forward Surge Current

